L Number	Hits	Search Text	DB	Time stamp
2	252	(printed near circuit near board or PCB) near2 antenna and bands	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/28 09:40
3	8110	ring near electrode$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/28 09:39
4	2	((printed near circuit near board or PCB) near2 antenna and bands) and (ring near electrode$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/28 09:39
5	1397	(printed near circuit near board or PCB) near2 antenna	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/28 09:40
6	9	((printed near circuit near board or PCB) near2 antenna) and 343/848.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/28 09:41

L Number	Hits	Search Text	DB	Time stamp
-	615	board and bands and sheet and plate and ring and metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:03
-	60	(board and bands and sheet and plate and ring and metal) and substrate and fragments	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:07
-	340	board and bands and sheet and plate and ring and metal and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:03
-	284	(board and bands and sheet and plate and ring and metal and substrate) and @ad<=20020920	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:34
-	4394	board and antenna and bands	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:07
-	23	(board and antenna and bands) and substrate and fragments	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:08
-	4	((printed near circuit near board or PCB) near antenna) and bands and substrate and sheet and ring$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:13
-	69	((printed near circuit near board or PCB) near antenna) and bands and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:11
-.	11	((printed near circuit near board or PCB) near antenna) and sheet and ring$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:15
-	43	chun near15 Ma.inv.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:15
-	649	(printed near circuit near board or PCB) near antenna	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:18
-	511	(board and bands and sheet and plate and ring and metal) and @ad<=20020920	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:40
-	2772	343/700ms.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:41
-	2431	343/702.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:41

-	540	343/795.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:41
-	337	343/841.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:41
-	804	343/846.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:41
-	7	((board and bands and sheet and plate and ring and metal) and @ad<=20020920) and 343/700ms.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:41
-	4	((board and bands and sheet and plate and ring and metal) and @ad<=20020920) and 343/702.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:41
-	1	((board and bands and sheet and plate and ring and metal) and @ad<=20020920) and 343/795.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:41
-	0	((board and bands and sheet and plate and ring and metal) and @ad<=20020920) and 343/841.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 13:41